# EEE104 – Digital Electronics (I) Lecture 6

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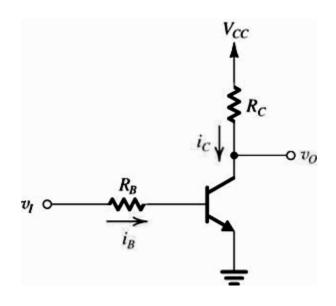
Dept of Electrical & Electronic Engineering

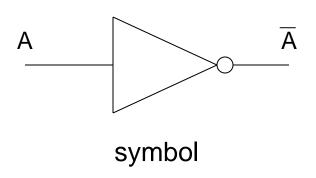
XJTLU

#### In This Session

- Transistors in a Gate
- Digital Integrated Circuits
- Integrated Circuit Logic Gates
  - Types and Series
  - Characteristics

#### Transistors in a Gate



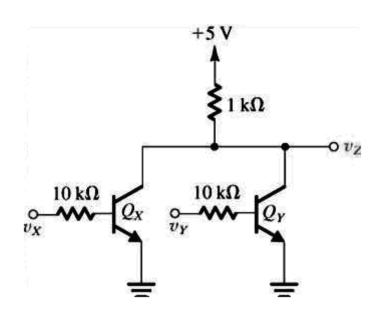


When a BJT is used as a switch, it operates between the cutoff and saturation modes.

- 1. If  $v_I$  is "0" or at a value close to ground, the BJT will be cutoff;  $v_O = V_{CC}$  (logic "1").
- 2. If  $v_I$  is "1" or at a value close to  $V_{CC}$ , the BJT will be saturated;  $v_O = V_{CEsat} \cong 0.2 \text{ V (logic "0")}$ .
- $\overline{A}$  3. This is a logic inverter.

Α	$\overline{A}$
0	1
1	0

### Transistors in a Gate



$V_X$	V <sub>Y</sub>	V <sub>Z</sub>
0.2 V	0.2 V	5 V
0.2 V	5 V	0.2 V
5 V	0.2 V	0.2 V
5 V	5 V	0.2 V

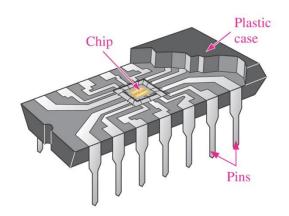
X	Υ	Z
0	0	1
0	1	0
1	0	0
1	1	0

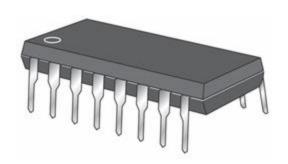
$$Z = \overline{X + Y}$$

**NOR Gate** 

#### The Integrated Circuit (IC)

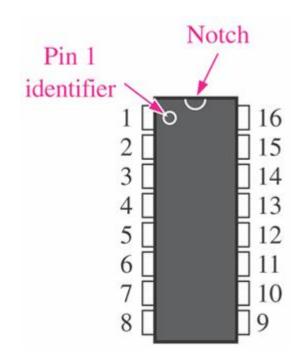
- It is an electronic circuit that is constructed entirely on a single small chip of silicon.
- The pins connect the internal points to allow inputs and outputs.
- Dual-in-line package (DIP) is the common IC package for small or medium-scale ICs.





#### **Pin Numbering for DIP**

- Pin 1 is indicated by either a small dot or a notch.
- With the notch oriented upward, pin numbers increase as you go down, then across and up.
- The highest pin number is the top right pin.



#### **Complexity Classification**

- **1. SSI**, small-scale integration, 1~12 gates, used for basic gates and flip-flops.
- 2. MSI, medium-scale integration, 13~99 gates, used for encoders, counters, registers, multiplexers, etc.
- **3. LSI**, large-scale integration, 100~9,999 gates, used for memories.
- 4. VLSI, Very large-scale integration, 10,000~99,999 gates.
- **5. ULSI**, ultra large-scale integration, 100,000 or more gates, used for microprocessors and large memories.

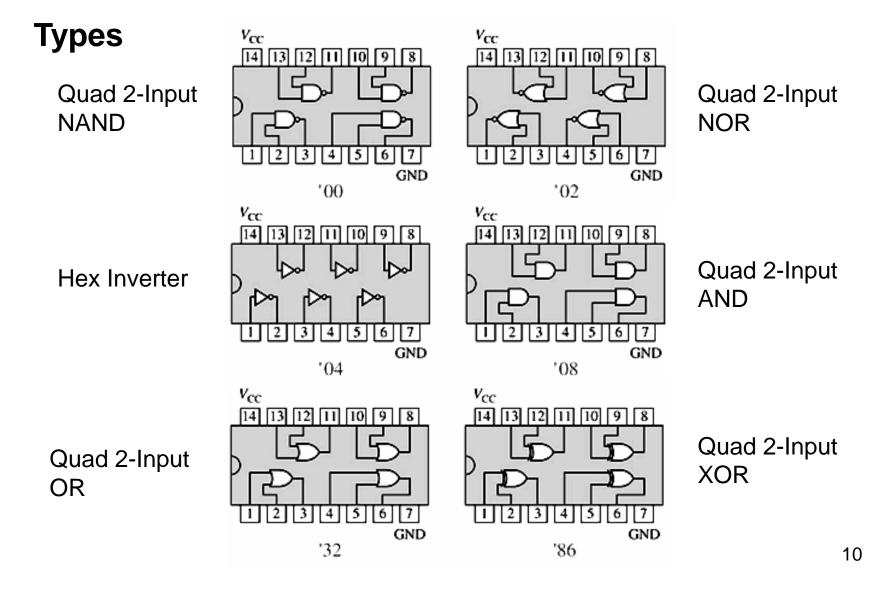
#### **Technologies**

- Bipolar junction transistors, such as TTL (transistortransistor logic) and ECL (emitter-coupled logic).
- MOSFETs, such as CMOS (complementary MOS) and NMOS (n-channel MOS).
- SSI and MSI circuits are available in both TTL and CMOS.
- LSI, VLSI and ULSI are implemented with CMOS or NMOS, because it is more compact and consumes less power.

#### **Designation**

Prefix + series + type, e.g. 74LS04.

- Prefix 74 for commercial grade, 54 for military grade.
- 2. Series a letter or letters to indicate the IC technology used, e.g. TTL or CMOS.
- 3. Type a number to indicate the type of logic device.



#### Series – TTL

74LS — Low-power Schottky TTL

74AS — Advanced Schottky TTL

74F — Fast TTL

#### Series - CMOS

74HC — High-speed CMOS

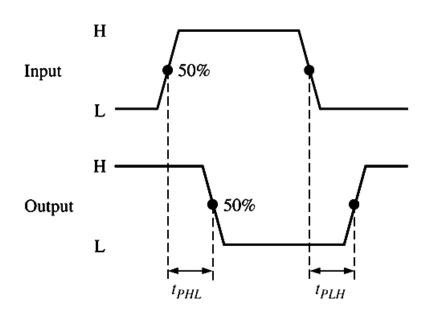
74HCT — High-speed CMOS, TTL compatibility

74AC — Advanced CMOS

74LVC — Low-voltage CMOS

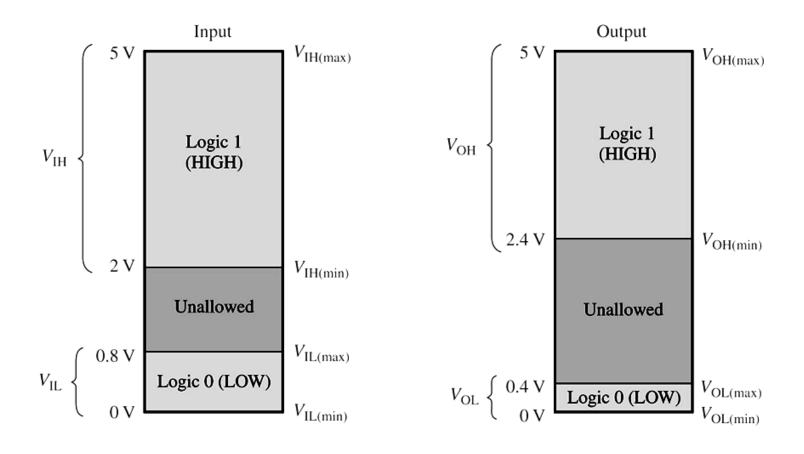
#### **Characteristics – Propagation Delay Time**

The time interval  $t_p$  between the application of an input pulse and the occurrence of the output pulse, e.g.  $t_{pHL}$  and  $t_{pLH}$ .

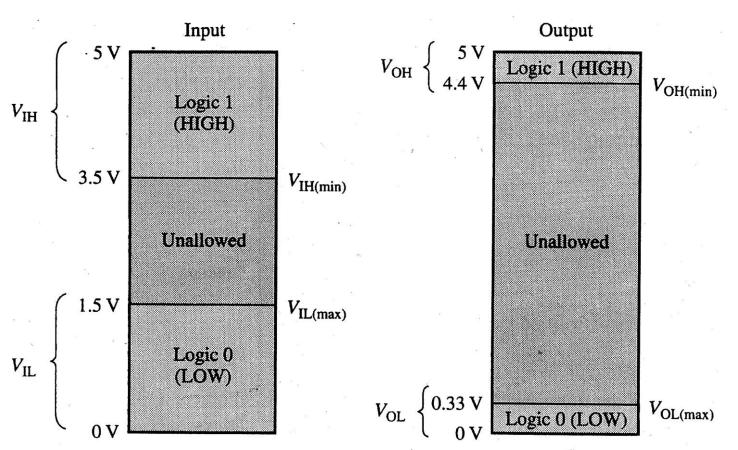


- The shorter t<sub>p</sub>, the higher the speed.
- 74LS series 11 ns
  74F series 3.3 ns
  74HCT series 7 ns
  74AC series 5 ns

#### **Characteristics – Input and output Logic Levels (TTL)**



## Characteristics – Input and Output Logic Levels (+5V CMOS)



#### Characteristics – DC Supply Voltage (V<sub>CC</sub>)

 There are two categories of CMOS: 5V CMOS and 3.3V CMOS (less power dissipation).

	Minimum	Typical	Maximum
TTL	4.5 V	5.0 V	5.5 V
5V CMOS	2.0 V	5.0 V	6.0 V
3.3V CMOS	2.0 V	3.3 V	3.6 V

 The supply voltage of CMOS can vary over a wider range than for TTL.

#### **Characteristics – Fan-Out**

- The fan-out is the maximum number of inputs that can be connected to a gate's output.
- Most TTL series, such as the 74LS, can drive 20 load gates.
- The fan-out for CMOS gates is very high.

